



NOTES:

- General Characteristics
  - Dimensions: 15.85x16.50x3.00H mm
  - Weight: Approx. 0.65g
  - Contact principle: Friction technology
  - Operating position: Shaft up/Down/Horizontal
  - Mounting System: SMT without post
  - Durability: 10,000 cycles min.
- Mechanical Characteristics:
  - Insulation Material: Thermoplastic, UL94V-0.
- Electrical Characteristics
  - Number of contacts: 6 pins
  - Contact resistance: 50 megohms typical, 100 megohms max.
  - Insulation resistance: >1000 megohms /500 VDC
- Solderability
  - Wave: Not applicable
  - Vaporphase: 215°C, 30 sec. MAX.
  - IR reflow: 230°C, 10~15 sec. MAX.
  - Manual soldering: 360°C, 3 sec. MAX.
- Environmental Characteristics
  - Operating temperature: -40°C ~ +85°C
  - Operating humidity: 10% ~ 95%RH
  - Storage temperature: -40°C, +85°C
  - Storage humidity: 10% ~ 95%RH
  - Thermal shock: -40°C ~ +85°C, 5 cycles
  - Damp Heat: 40°C, 90%RH, 500HR
  - Salt-mist: 35°C, 5%, NaCl, 48H

<p>RoHS Compliant</p>		<p><b>HSM</b> 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.</p>	
<p>APPD. 核准</p>		<p>TOLERANCE 容許公差</p> <p>.0 ± 0.30</p> <p>.00 ± 0.20</p> <p>ANG. ± 3°</p>	<p>PART NAME 品名</p> <p>SIM CARD CONNECTOR 6P SMT TYPE</p> <p>SELECTIVE GOLD PLATING</p> <p>WITH SWITCH BLACK COLOR ROHS</p>
<p>DWG. 製圖</p> <p>Betty</p>	<p>SCALE 比例 參考</p> <p>UNIT 單位</p> <p>MM</p>	<p>SIZE. 紙張尺寸</p> <p>A 4</p>	<p>PART NO.</p> <p>C0643-06DSYBX0R</p>
<p>DATE 制表日</p> <p>2014/11/11</p>	<p>PAGE 張數</p> <p>1 OF 1</p>	<p>REV. 版次</p> <p>B</p>	<p>料號</p> <p>C0643-06DSYBX0R</p>